



# PRELIMINARY

## QuikPAC Module Data

# XD010-35S

## 10W, 2110-2170MHz

### CDMA Driver Amplifier

### General description:

The XD010-35S QuikPAC™ 10W power module is a 2-stage Class A/AB amplifier module for use in the driver stages of CDMA RF power amplifiers for cellular base stations. The power transistors are fabricated using Xemod's latest, high performance LDMOS II process. This unit operates from a single voltage and has internal temperature compensation of the bias voltage to ensure stable performance over the full temperature range.

### Features:

Single Voltage Operation  
High Gain  
High Efficiency  
Advanced, XeMOS II LDMOS FETS  
Stable Performance  
50  $\Omega$  RF impedance  
QuikPAC System Compatible

### Standard Operating Conditions

Parameter	Symbol	Min	Nom	Max	Units
Frequency Range	F	2110		2170	MHz
Supply (Drain) Voltage	V <sub>D</sub>		28		VDC
Input and Output Impedance	$\Omega$		50		Ohms
Load Impedance for Stable Operation (All Phases)	VSWR			10:1	
Baseplate Temperature	T <sub>OP</sub>	-20		+90	°C

### Maximum Ratings

Parameter	Symbol	Value	Units
Supply (Drain) Voltage	V <sub>DD</sub>	35	VDC
Input RF Power	P <sub>IN</sub>	+23	dBm
Load Impedance for continuous operation without damage	VSWR	5/1	
Output Device Channel Temperature		200	°C
Lead Temperature during reflow soldering		+210	°C
Storage Temperature	T <sub>STG</sub>	-40 to +100	°C

### Performance at 25°C

Parameter	Symbol	Min	Nom	Max	Units
Supply Voltage	V <sub>D1,2</sub>	27.8	28.0	28.2	VDC
Power Output at 1 dB Compression (single tone)	P <sub>-1</sub>		12		W
Gain at 1W Output (CW)	G		27.5		dB
Gain Flatness over frequency at 1W Output (CW)	$\Delta G$		0.2	0.5	dB
Input Return Loss at 1W Output (CW) (50 $\Omega$ Ref)	iRL		20.0		dB
Quiescent Current	I <sub>DQ</sub>		350		mA
Drain Efficiency at 10W CW output	$\eta_D$		29.0		%
Drain Efficiency at 1W W-CDMA output	$\eta_D$		6.5		%
ACPR at 1W SC W-CDMA Power Output (1)			-51		dB
3 <sup>rd</sup> order IMD at 10W PEP (two- tone)			-30		dBc
Electrical Delay			3.0		ns

(1) W-CDMA Signal is 3GPP Test Model 1 64 User

XEMOD RESERVES THE RIGHT TO MAKE CHANGES TO THIS SPECIFICATION WITHOUT FURTHER NOTICE. BEFORE THE PRODUCT DESCRIBED HERE IS WRITTEN INTO SPECIFICATIONS OR USED IN CRITICAL APPLICATIONS, THE PERFORMANCE CHARACTERISTICS SHOULD BE VERIFIED BY CONTACTING XEMOD.

## Performance Over Temperature

Parameter	Symbol	Min	Nom	Max	Units
Power Output at 1 dB Compression (single tone)	$P_{-1}$		10		W
Gain at 1W Output (CW)	G		27.0		dB
Gain Flatness over frequency at 1W Output (CW)	$\Delta G$		0.3	0.7	dB
Input Return Loss at 1W Output (CW) (50 $\Omega$ Ref)	iRL		18.0		dB
Drain Efficiency at 10W CW output	$\eta_D$		28		%
Drain Efficiency at 1W W-CDMA output	$\eta_D$		6.5		%
ACPR at 1W W-CDMA Power Output			-51		dB

### Notes:

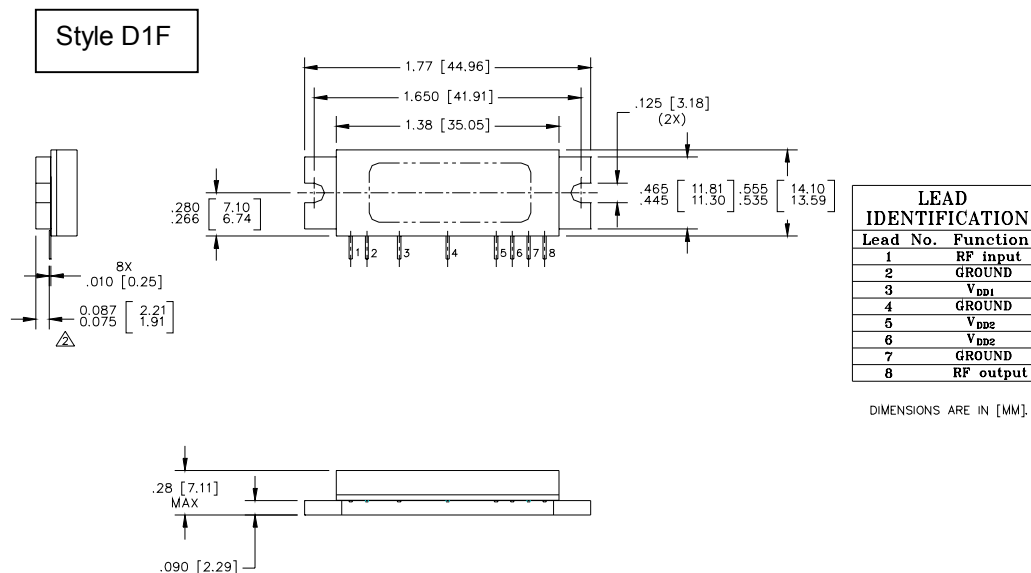
The "Preliminary" designation on this data sheet indicates this product has not yet entered production. The data supplied here is derived from engineering development and pilot production testing and may change.

The internal generated gate voltage is thermally compensated to maintain constant quiescent current over the temperature range listed in the data sheet. No compensation is provided for gain changes with temperature. This can only be provided with AGC external to the module.

Internal RF decoupling is included on all bias leads. No additional bypass elements are required, however some applications may require energy storage on the drain leads to accommodate time-varying waveforms.

The RF leads are internally protected against DC voltages up to 100V. Care should be taken to avoid video transients that may damage the active devices.

### Package Styles



This model is available in the D1F (H11822) and D2F (H12048) package styles. Style D1F is shown here for reference only. Style D2F is the same except the three ground leads are not present.

Please see the applicable outline drawing for detailed dimensions.